HL-LHC Upgrades to the ATLAS Hadronic Tile Calorimeter Readout Electronics

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The ATLAS Hadronic Tile Calorimeter



Daughterboard: Tile readout-out link

Control & readout interface for the upgraded TileCal front end systems



The High-Luminosity LHC Era

- TileCal essential for measurement of jet/missing energy, jet substructure, electron isolation, and triggering
- Increase in luminosity makes HL-LHC challenging in terms of radiation hardness and triggering
- Phase-II trigger system redesigned with fully digital trigger to improve selectivity
 - access to digital info from each Ο calorimeter cell with low noise and accurate energy calibration
- Electronic components must be replaced to survive higher radiation environment

Daughterboard Upgrades

- Migration to Kintex Ultrascale (KU) FPGAs
 - Single Event Latch-Up (SEL) observed in Ultrascale+ Ο
- New remote JTAG interface design using FPGAs (ProASIC3)
 - Improved reliability, buffering, voltage translation Ο
- DC-DC regulation w/ failsafe power-up sequencing, improved monitoring, and over-current protection
- Optimized routing of ADC data & clocks to FPGA banks for better timing performance

Upgrade Test Boards





Aux Component Irradiation Board

Daughterboard v6





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SEU / SEL Tests

- FPGAs tested w/ 226 MeV proton beam at IFJ Krakow
- Fluence:
 1.11E+12 p/cm²
- KU SEU rate: 166 SEU/1.4E+9 p/cm²
 - Negligible disruption to HL data taking
 - Not all FPGA logic used, Triple Mode Redundancy, Xilinx Soft Error Manager
- No latch-up observed (SEL)



Upcoming Irradiations

- NIEL at Ljubljana TRIG A Mark II
 9E+12 n/cm² (1 MeV equivalent)
- TID at Stockholm U. facility
 - 15 kRad + annealing

Daughterboard Production

- 1085 DBs will be produced
- 896 installed in ATLAS
- Small batch to be produced this year
- Final Design Review completed 2021
- Stockholm U. ATLAS Production Lab:
 - 2 test benches, for production testing and debugging in parallel
 - Burn-in oven capacity up to 40
 DBs, with temperatures up to 85C

